1. General description

Logic level N-channel MOSFET in an LFPAK33 (Power33) package using TrenchMOS technology. This product has been designed and qualified to AEC Q101 standard for use in high performance automotive applications.

2. Features and benefits

- Q101 compliant
- Repetitive avalanche rated
- Suitable for thermally demanding environments due to 175 °C rating
- True logic level gate with $V_{GS(th)}$ rating of greater than 0.5 V at 175 °C

3. Applications

- 12 V, 24 V and 48 V automotive systems
- Motors, lamps and solenoid control
- Transmission control
- Ultra high performance power switching

4. Quick reference data

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$V_{DS}$</td>
<td>drain-source voltage</td>
<td>$25 , ^\circ C \leq T_j \leq 175 , ^\circ C$</td>
<td>-</td>
<td>-</td>
<td>100</td>
<td>V</td>
</tr>
<tr>
<td>$I_D$</td>
<td>drain current</td>
<td>$V_{GS} = 5 , V; \ T_{mb} = 25 , ^\circ C; \ Fig. \ 2$</td>
<td>-</td>
<td>-</td>
<td>29</td>
<td>A</td>
</tr>
<tr>
<td>$P_{tot}$</td>
<td>total power dissipation</td>
<td>$T_{mb} = 25 , ^\circ C; \ Fig. \ 1$</td>
<td>-</td>
<td>-</td>
<td>79</td>
<td>W</td>
</tr>
</tbody>
</table>

Static characteristics

- $R_{Dson}$ | drain-source on-state resistance | $V_{DS} = 5 \, V; \ I_D = 5 \, A; \ T_j = 25 \, ^\circ C; \ Fig. \ 11$ | -   | 29  | 34  | mΩ   |

Dynamic characteristics

- $Q_{GD}$ | gate-drain charge | $I_D = 10 \, A; \ V_{DS} = 80 \, V; \ V_{GS} = 5 \, V; \ T_j = 25 \, ^\circ C; \ Fig. \ 13; \ Fig. \ 14$ | -   | 10.3| -   | nC   |
5. Pinning information

Table 2. Pinning information

<table>
<thead>
<tr>
<th>Pin</th>
<th>Symbol</th>
<th>Description</th>
<th>Simplified outline</th>
<th>Graphic symbol</th>
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<tr>
<td>1</td>
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<td>Source</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2</td>
<td>S</td>
<td>Source</td>
<td></td>
<td></td>
</tr>
<tr>
<td>3</td>
<td>S</td>
<td>Source</td>
<td></td>
<td></td>
</tr>
<tr>
<td>4</td>
<td>G</td>
<td>Gate</td>
<td></td>
<td></td>
</tr>
<tr>
<td>mb</td>
<td>D</td>
<td>Mounting base; connected to drain</td>
<td>LFPAK33 (SOT1210)</td>
<td></td>
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</table>

6. Ordering information

Table 3. Ordering information

<table>
<thead>
<tr>
<th>Type number</th>
<th>Package</th>
<th>Name</th>
<th>Description</th>
<th>Version</th>
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</thead>
<tbody>
<tr>
<td>BUK9M34-100E</td>
<td>LFPAK33</td>
<td>Plastic single ended surface mounted package (LFPAK33); 8 leads</td>
<td>SOT1210</td>
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</tr>
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7. Marking

Table 4. Marking codes

<table>
<thead>
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<th>Type number</th>
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<tr>
<td>BUK9M34-100E</td>
<td>93410E</td>
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</table>

8. Limiting values

Table 5. Limiting values

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>V_DS</td>
<td>drain-source voltage</td>
<td>25 °C ≤ T_j ≤ 175 °C</td>
<td>-</td>
<td>100</td>
<td>V</td>
</tr>
<tr>
<td>V_DGR</td>
<td>drain-gate voltage</td>
<td>R_GS = 20 kΩ</td>
<td>-</td>
<td>100</td>
<td>V</td>
</tr>
<tr>
<td>V_GS</td>
<td>gate-source voltage</td>
<td>DC; T_j ≤ 175 °C</td>
<td>-10</td>
<td>10</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Pulsed; T_j ≤ 175 °C</td>
<td>-15</td>
<td>15</td>
<td>V</td>
</tr>
<tr>
<td>P_tot</td>
<td>total power dissipation</td>
<td>T_mb = 25 °C; Fig. 1</td>
<td>-</td>
<td>79</td>
<td>W</td>
</tr>
<tr>
<td>I_D</td>
<td>drain current</td>
<td>V_GS = 5 V; T_mb = 25 °C; Fig. 2</td>
<td>-</td>
<td>29</td>
<td>A</td>
</tr>
<tr>
<td></td>
<td></td>
<td>V_GS = 5 V; T_mb = 100 °C; Fig. 2</td>
<td>-</td>
<td>20.1</td>
<td>A</td>
</tr>
<tr>
<td>I_DM</td>
<td>peak drain current</td>
<td>pulsed; t_R ≤ 10 µs; T_mb = 25 °C; Fig. 3</td>
<td>-</td>
<td>114</td>
<td>A</td>
</tr>
</tbody>
</table>
N-channel 100 V, 34 mΩ logic level MOSFET in LFPAK33

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Max</th>
<th>Unit</th>
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</thead>
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<tr>
<td>$T_{stg}$</td>
<td>storage temperature</td>
<td></td>
<td>-55</td>
<td>175</td>
<td>°C</td>
</tr>
<tr>
<td>$T_j$</td>
<td>junction temperature</td>
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<td>-55</td>
<td>175</td>
<td>°C</td>
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**Source-drain diode**

<table>
<thead>
<tr>
<th>Symbol</th>
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<th>Conditions</th>
<th>Min</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$I_S$</td>
<td>source current</td>
<td>$T_{mb} = 25$ °C</td>
<td>-</td>
<td>29</td>
<td>A</td>
</tr>
<tr>
<td>$I_{SM}$</td>
<td>peak source current</td>
<td>pulsed; $t_p \leq 10$ µs; $T_{mb} = 25$ °C</td>
<td>-</td>
<td>114</td>
<td>A</td>
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</tbody>
</table>

**Avalanche ruggedness**

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$E_{DS(AL)}S$</td>
<td>non-repetitive drain-source avalanche energy</td>
<td>$I_D = 29$ A; $V_{sup} \leq 100$ V; $R_{GS} = 50$ Ω; $V_{GS} = 5$ V; $T_{j(init)} = 25$ °C; unclamped; Fig. 4</td>
<td>-</td>
<td>57.8</td>
<td>mJ</td>
</tr>
</tbody>
</table>

[1] Accumulated pulse duration up to 50 hours delivers zero defect ppm.
[2] Significantly longer life times are achieved by lowering $T_j$ and $V_{GS}$
[3] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.
[4] Refer to application note AN10273 for further information.

![Fig. 1. Normalized total power dissipation as a function of mounting base temperature](image)

$$P_{der} = \frac{P_{tot}}{P_{tot(25°C)}} \times 100\%$$

![Fig. 2. Continuous drain current as a function of mounting base temperature](image)

$$V_{GS} \geq 5\text{ V}$$

$$I_D = 29A \times \sqrt{\frac{175°C - T_{mb}}{150°C}} \text{ for } T_{mb} \geq 25°C$$
Fig. 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

(1) $T_j(\text{init}) = 25 \, ^\circ\text{C}$; (2) $T_j(\text{init}) = 150 \, ^\circ\text{C}$; (3) Repetitive Avalanche

Fig. 4. Avalanche rating; avalanche current as a function of avalanche time

9. Thermal characteristics

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$R_{th(j-mb)}$</td>
<td>thermal resistance from junction to mounting base</td>
<td>Fig. 5</td>
<td>-</td>
<td>1.58</td>
<td>1.89</td>
<td>K/W</td>
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10. Characteristics

Table 7. Characteristics

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
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</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>Static characteristics</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>$V_{BRDSS}$</td>
<td>drain-source breakdown voltage</td>
<td>$I_D = 250 \mu A; V_{GS} = 0 \text{ V}; T_J = 25 \text{ °C}$</td>
<td>100</td>
<td>-</td>
<td>-</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$I_D = 250 \mu A; V_{GS} = 0 \text{ V}; T_J = -55 \text{ °C}$</td>
<td>90</td>
<td>-</td>
<td>-</td>
<td>V</td>
</tr>
<tr>
<td>$V_{GS(th)}$</td>
<td>gate-source threshold voltage</td>
<td>$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_J = 25 \text{ °C}$;</td>
<td>1.4</td>
<td>1.7</td>
<td>2.1</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{DS} = V_{GS}; T_J = -55 \text{ °C}$; Fig. 9; Fig. 10</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_J = 175 \text{ °C}$;</td>
<td>0.5</td>
<td>-</td>
<td>-</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Fig. 10</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>$I_{DSS}$</td>
<td>drain leakage current</td>
<td>$V_{DS} = 100 \text{ V}; V_{GS} = 0 \text{ V}; T_J = 25 \text{ °C}$</td>
<td>-</td>
<td>0.01</td>
<td>1</td>
<td>$\mu A$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{DS} = 100 \text{ V}; V_{GS} = 0 \text{ V}; T_J = 175 \text{ °C}$</td>
<td>-</td>
<td>-</td>
<td>500</td>
<td>$\mu A$</td>
</tr>
<tr>
<td>$I_{GSS}$</td>
<td>gate leakage current</td>
<td>$V_{GS} = 10 \text{ V}; V_{DS} = 0 \text{ V}; T_J = 25 \text{ °C}$</td>
<td>-</td>
<td>2</td>
<td>100</td>
<td>nA</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{GS} = -10 \text{ V}; V_{DS} = 0 \text{ V}; T_J = 25 \text{ °C}$</td>
<td>-</td>
<td>2</td>
<td>100</td>
<td>nA</td>
</tr>
<tr>
<td>$R_{DSon}$</td>
<td>drain-source on-state resistance</td>
<td>$V_{GS} = 5 \text{ V}; I_D = 5 \text{ A}; T_J = 25 \text{ °C}$; Fig. 11</td>
<td>-</td>
<td>29</td>
<td>34</td>
<td>m$\Omega$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{GS} = 10 \text{ V}; I_D = 5 \text{ A}; T_J = 25 \text{ °C}$; Fig. 11</td>
<td>-</td>
<td>28</td>
<td>34</td>
<td>m$\Omega$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{GS} = 5 \text{ V}; I_D = 5 \text{ A}; T_J = 175 \text{ °C}$; Fig. 12</td>
<td>-</td>
<td>-</td>
<td>97</td>
<td>m$\Omega$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Dynamic characteristics</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>$Q_G(tot)$</td>
<td>total gate charge</td>
<td>$I_D = 10 \text{ A}; V_{DS} = 80 \text{ V}; V_{GS} = 5 \text{ V}$;</td>
<td>-</td>
<td>24.7</td>
<td>-</td>
<td>nC</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_J = 25 \text{ °C}$; Fig. 13; Fig. 14</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>$Q_{GS}$</td>
<td>gate-source charge</td>
<td>$T_J = 25 \text{ °C}$; Fig. 13; Fig. 14</td>
<td>-</td>
<td>4.9</td>
<td>-</td>
<td>nC</td>
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<tr>
<td>$Q_{GD}$</td>
<td>gate-drain charge</td>
<td></td>
<td>-</td>
<td>10.3</td>
<td>-</td>
<td>nC</td>
</tr>
</tbody>
</table>

Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration
Symbol | Parameter | Conditions | Min | Typ | Max | Unit
--- | --- | --- | --- | --- | --- | ---
Ciss | input capacitance | $V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}; T_j = 25 ^\circ\text{C}; \text{ Fig. 15}$ | - | 2138 | 2844 | pF
Coss | output capacitance | - | 135 | 162 | pF
Crss | reverse transfer capacitance | - | 85 | 117 | pF
td(on) | turn-on delay time | $V_{DS} = 80 \text{ V}; R_L = 5 \Omega; V_{GS} = 5 \text{ V}; R_G(\text{ex}) = 5 \Omega; T_j = 25 ^\circ\text{C}$ | - | 12.1 | - | ns
t | rise time | - | 26.2 | - | ns
td(off) | turn-off delay time | - | 36 | - | ns
tf | fall time | - | 22 | - | ns

Source-drain diode

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
--- | --- | --- | --- | --- | --- | --- |
VSD | source-drain voltage | $I_S = 5 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^\circ\text{C}; \text{ Fig. 16}$ | - | 0.81 | 1.2 | V
trr | reverse recovery time | $I_S = 10 \text{ A}; \text{ d}I_S/\text{d}t = -100 \text{ A/}\mu\text{s}; V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; T_j = 25 ^\circ\text{C}$ | - | 31 | - | ns
Qr | recovered charge | - | 46 | - | nC

Fig. 6. Output characteristics; drain current as a function of drain-source voltage; typical values
Fig. 7. Drain-source on-state resistance as a function of gate-source voltage; typical values
Nexperia

BUK9M34-100E

N-channel 100 V, 34 mΩ logic level MOSFET in LFPAK33

---

**Fig. 8.** Transfer characteristics; drain current as a function of gate-source voltage; typical values

\[
V_{DS} = 12 \text{ V} \quad \text{V}_{\text{G}} = 2.4 \text{ V} \quad \text{V}_{\text{G}} = 2.6 \text{ V} \quad \text{V}_{\text{G}} = 2.8 \text{ V} \quad \text{T}_j = 25 \degree \text{C} \]

**Fig. 9.** Sub-threshold drain current as a function of gate-source voltage

\[
T_j = 25 \degree \text{C} \quad V_{DS} = 5 \text{ V} \]

---

**Fig. 10.** Gate-source threshold voltage as a function of junction temperature

\[
I_D = 1 \text{ mA} \quad V_{DS} = V_{GS} \quad \text{T}_j = 25 \degree \text{C} \]

---

**Fig. 11.** Drain-source on-state resistance as a function of drain current; typical values

\[
T_j = 25 \degree \text{C} \]

---
Fig. 12. Normalized drain-source on-state resistance factor as a function of junction temperature

\[ a = \frac{R_{DSON}}{R_{DSON(25\,^\circ\text{C})}} \]

Fig. 13. Gate-source voltage as a function of gate charge; typical values

\[ V_{GS} \text{ (V)} \]

\[ Q_{G} \text{ (nC)} \]

\[ T_{j} = 25 \, ^\circ\text{C}; I_{D} = 10 \, \text{A} \]

Fig. 14. Gate charge waveform definitions

\[ V_{DS} \]

\[ V_{GS}\text{(p)} \]

\[ V_{GS}\text{(n)} \]

\[ V_{GS} \]

\[ Q_{GS1} \]

\[ Q_{GS} \]

\[ Q_{GSO} \]

\[ Q_{GDO} \]

\[ Q_{G(tot)} \]

\[ I_{D} \]

Fig. 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

\[ C \text{ (pF)} \]

\[ C_{iss} \]

\[ C_{iss} \]

\[ C_{oss} \]

\[ C_{rss} \]

\[ V_{GS} = 0 \, \text{V}; f = 1 \, \text{MHz} \]

\[ V_{DS} \text{ (V)} \]
**11. Application information**

For guidance on how to use and understand this datasheet, please refer to application note AN11158 "Understanding power MOSFET datasheet parameters".

---

**Fig. 16. Source-drain (diode forward) current as a function of source-drain (diode forward) voltage; typical values**

\[ V_{GS} = 0 \text{ V} \]
12. Package outline

Plastic single ended surface mounted package (LFPAK33): 8 leads

Fig. 17. Package outline LFPAK33 (SOT1210)
13. Legal information

13.1 Data sheet status

<table>
<thead>
<tr>
<th>Document status</th>
<th>Product status</th>
<th>Definition</th>
</tr>
</thead>
<tbody>
<tr>
<td>Objective [short] data sheet</td>
<td>Development</td>
<td>This document contains data from the objective specification for product development.</td>
</tr>
<tr>
<td>Preliminary [short] data sheet</td>
<td>Qualification</td>
<td>This document contains data from the preliminary specification.</td>
</tr>
<tr>
<td>Product [short] data sheet</td>
<td>Production</td>
<td>This document contains the product specification.</td>
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</table>

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term “short data sheet” is explained in section “Definitions”.

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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